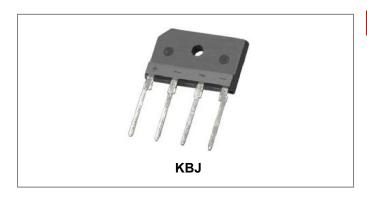






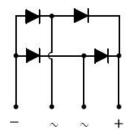
# KBJ4005G THRU KBJ410G GLASS PASSIVATED SINGLE-PHASE BRIDGE RECTIFIER



#### **Features**

- Glass passivated chip junction KBJ
- Reliable low cost construction utilizing molded plastic technique
- Ideal for printed circuit board
- Low forward voltage drop
- Low reverse leakage current
- High surge current capability
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

# **Circuit Diagram**



### **Mechanical Data**

- Case: Molded plastic, KBJ
- Epoxy: UL 94V-O rate flame retardant
- Terminals: Leads solderable per MIL-STD-202,
- method 208 guaranteed
  Mounting position: Any
- Weight: 0.16ounce, 4.6gram

#### Maximum Ratings:@T<sub>A</sub>=25°C unless otherwise specified

Single Phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Type Number	Symbol	KBJ 4005G	KBJ 401G	KBJ 402G	KBJ 404G	KBJ 406G	KBJ 408G	KBJ 410G	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$egin{array}{c} V_{RRM} \ V_{DC} \end{array}$	50	100	200	400	600	800	1000	V
RMS Reverse Voltage	$V_{RMS}$	35	70	140	280	420	560	700	V
Average forward rectified output current @T <sub>C</sub> = 115°C	lo	4.0					А		
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I <sub>FSM</sub>	120					А		

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     sales@ smc-diodes.com







# Electrical Characteristics:@TA=25°C unless otherwise specified

Type Number	Symbol	KBJ 4005G	KBJ 401G	KBJ 402G	KBJ 404G	KBJ 406G	KBJ 408G	KBJ 410G	Units
Forward Voltage (per element) @I <sub>F</sub> =2A @I <sub>F</sub> =4A	V <sub>F</sub>				1.0 1.1				V
Peak Reverse Current @T <sub>A</sub> = 25°C At Rated DC Blocking Voltage @T <sub>A</sub> = 125°C	I <sub>RM</sub>	5.0 500					μA		
Typical Junction Capacitance(per leg) (Note 1)	С				40				pF

<sup>\*</sup> Pulse width < 300  $\mu$ s, duty cycle < 2%

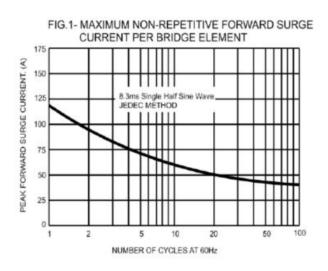
### Thermal-Mechanical Specifications:@TA=25°C unless otherwise specified

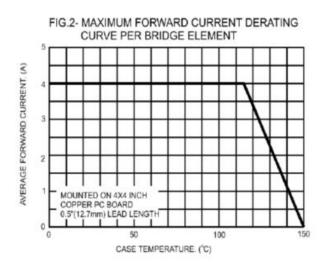
Type Number	Symbol	KBJ 4005G	KBJ 401G	KBJ 402G	KBJ 404G	KBJ 406G	KBJ 408G	KBJ 410G	Units
Typical Thermal Resistance(Note 2)	R <sub>θJC</sub>	5.5						°C/W	
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150						°C	

Note: 1. Measured at 1 MHZ and applied reverse voltage of 4.0 VDC.

2. Thermal Resistance from Junction to Case with Device Mounted on 75mm x 75mm x 1.6mm Cu Plate Heatsink.

## **Ratings and Characteristics Curves**



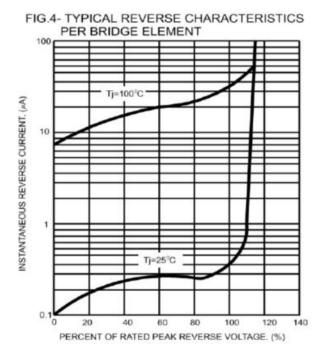


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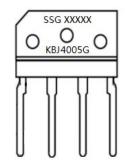


# **Ordering Information**

Device	Package	Shipping				
KBJ4005G THRU KBJ410G	KBJ(Pb-Free)	20pcs / tube				

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

# **Marking Diagram**



Where XXXXX is YYWWL

SSG = SSG YY = Year WW = Week L = Lot Number KBJ4005G = Type Number

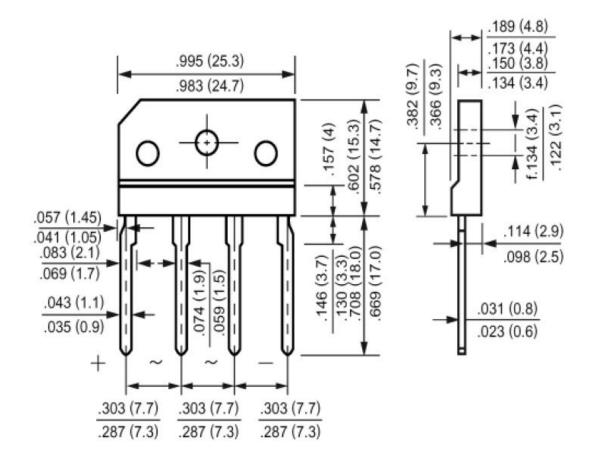
**Cautions:** Molding resin Epoxy resin UL:94V-0







# **Mechanical Dimensions KBJ (Inches/Millimeters)**



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